

189.00 EUR  
incl. 19% VAT, plus [shipping](#)



- Full-size M.2 !
- 5G / LTE !
- Sub6 Network !
- Generic version !

**Support:** [Specifications](#) | [AT Command Guide](#) | [Driver \(Windows\)](#)

Fibocom's global 5G module FM350-GL is based on Mediatek T700 chipset and supports both 5G SA and NSA network architectures with faster transmission speed, better carrying capacity and lower network latency.

FM350-GL supports 5G NR Sub-6 bands with fallback to LTE and WCDMA standards, eliminating customers' investment concerns in the initial stage of 5G construction and responding to the commercial demand of rapid landing. It provides perfect high-speed experience for customers in the fields of gateways, industrial monitoring, remote medical treatment, UAV, virtual reality (VR / AR) and more.

Region	Europe North America South America Australia Japan APAC	
PRIMARY TECHNOLOGY	5G	
Fallback	4G LTE / 3G	
FORM FACTOR	M.2 3052	
5G BANDS	n1 (FDD 2100), n2 (FDD 1900), n3 (FDD 1800), n5 (FDD 850), n7 (FDD 2600), n8 (FDD 900), n20 (FDD 800), n25 (FDD 1900), n28 (FDD 700), n30 (FDD 2300), n38 (TDD 2600), n40 (TDD 2300), n41 (TDD 2500), n48 (TDD 3600), n66 (FDD 1700 / AWS-3), n71 (FDD 600), n77 (TDD 3700), n78 (TDD 3500), n79 (TDD 4500)	
LTE BANDS	B1 (FDD 2100), B2 (FDD 1900), B3 (FDD 1800), B4 (FDD 1700 / AWS), B5 (FDD 850), B7 (FDD 2600), B8 (FDD 900), B12 (FDD 700ac), B13 (FDD 700c), B14 (FDD 700PS), B17 (FDD 700bc), B18 (FDD 800), B19 (FDD 800), B20 (FDD 800DD), B25 (FDD 1900), B26 (FDD 850), B28 (FDD 700), B29 (SDL 700), B30 (FDD 2300), B32 (SDL 1500), B34 (TDD 2000), B38 (TDD 2600), B39 (TDD 1900), B40 (TDD 2300), B41 (TDD 2500), B42 (TDD 3500), B43 (TDD 3600), B46 (TDD 5200), B48 (TDD 3600), B66 (FDD 1700 / AWS-3), B71 (FDD 600)	
UMTS BANDS	B1 (2100), B2 (1900), B8 (900), B4 (AWS), B5 (850)	
MAX SPEED	4670 Mbps DL / 1250 Mbps UL	

GNSS	QZSS GPS GLONASS Galileo BeiDou
ANTENNA CONNECTORS	IPEX MHF-4
CERTIFICATION	Telec SRRC RCM PTCRB NCC Jate CE RED FCC IC GCF CTA CE CCC
CARRIER CERTIFICATION	Vodafone Verizon TMO Telstra Telefonica T-Mobile Swisscom Softbank Optus NTT DOCOMO KDDI Deutsche Telekom AT&T
OPERATING TEMPERATURE RANGE	-10 °C – 55 °C
Chipset	T700 / MediaTek
DRIVER SUPPORT	Windows Linux
SIM Interface	Through M.2 connector Dual SIM interface